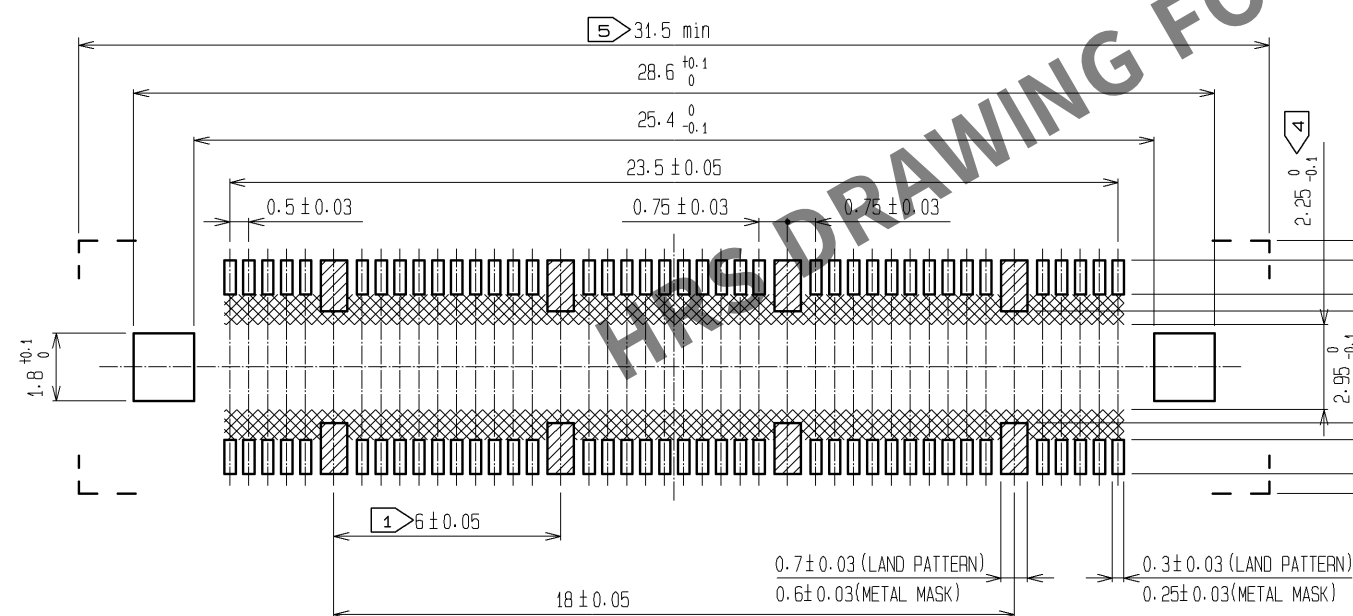


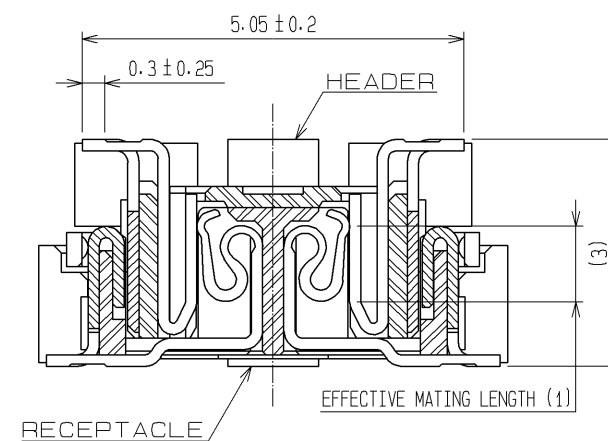
RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)



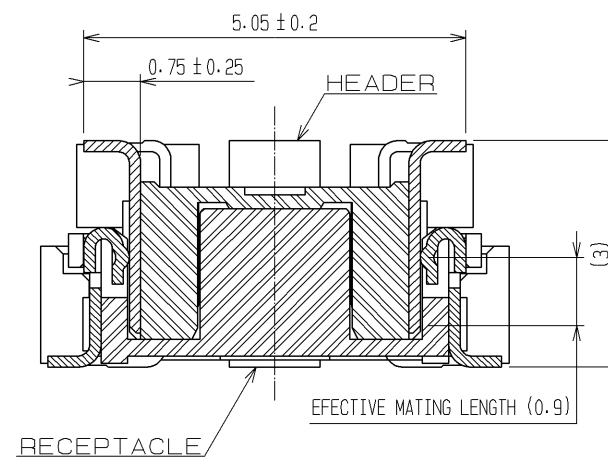
NOTES

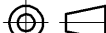
- 1 8 HATCHED  PARTS:GROUND CIRCUIT.
- 2 SMT LEAD-COPLANARITY:0.1 MAX.
- 3 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
- 4 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND ,OR LEAD MAY TOUCH PATTERN.(THIS APPLIES TO HATCHED  AREA.)
- 5 DO NOT MOUNT OTHER DEVICES ONTO [] AREA ,OR MATING PAIR CANNOT BE MATED.
- 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

SIGNAL PORTION CROSS SECTION (10:1)



GROUND PORTION CROSS SECTION (10:1)



			2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.					
					LEAD AREA : GOLD 0.05μm min.					
					UNDER PLATING : NICKEL 1μm min.					
3. 4	PHOSPHOR BRONZE	TIN PLATING								
1	LCP	BEIGE UL94V-0								
NO.	MATERIAL		FINISH . REMARKS		NO.	MATERIAL		FINISH . REMARKS		
UNITS mm			SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		12. 03. 12		DRAWING NO.		EDC3-152619-25		
		CHECKED : HT. YAMAGUCHI		12. 03. 12		PART NO.		FX11B-80P/8-SV0. 5(71)		
		DESIGNED : TS. MIYAKI		12. 03. 12		CODE NO.		CL573-0613-0-71		
		DRAWN : TS. MIYAKI		12. 03. 12				 		